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SMART ENERGY 13/12TH PROCESSOR

FANLESS COMPUTER



- Intel®13th /12th Gen Raptor Lake-S / Alder Lake-S
 Core[™] i9/i7/i5/i3 up to TDP 65W
- Up to 64G DDR4 SO-DIMM 3200 MHz
- 2 x DP, 2 x LAN, 6x USB
- 2x 2.5"Easy swap SSD Tray
- 2 x PCIe Gen4 x 8 slot
- DC-IN 16~31V(With Redundant)
- Operation Temp. -20°C to 60°C

Specifications

SYSTEM

CPU	13th/12th Gen Intel® Raptor Lake-S/Alder Lake-S LGA1700 Socket Processor / Core i9/i7/i5/i3 Processor up to TDP 65W		
Memory Capacity	DDR4 SO-DIMM 3200 MHz up to 64G		
Chipset	Q670		
DISPLAY			
GPU	Intel [®] UHD Graphics		
Display Port	DisplayPort 1.4, DP++ Max resolution up to 4k (4096x2304@60Hz)		
2 nd Display Port	DisplayPort 1.4, DP++ Max resolution up to 4k (4096x2304@60Hz)		
EXPANSION			
PCIe Slot	2 x PCle Gen4 x 8 Slot		
M.2	1x M.2 2280M-key (PCIe Gen 3.0 X 4, SATAIII)		
STORAGE			
SATA	Up to 4TB SATAIII		
M.2	Up to 2TB NVMe & SATAIII		
ETHERNET			
Ethernet	Intel® I219-LM Giga LAN		
FRONT I/O			
Power Button	1 x Power Button		
Indicator	1 x HDD backlight / 1 x Power backlight		
USB3.0	2 x USB 3.0		
REAR I/O			
Power Input	1 x 4P Terminal Block 16~31V DC-IN (2 x 4P Terminal Block 16~31V DC-IN with Redundant)		
LAN	2 x 1GbE RJ45		
USB3.2	2 x USB 3.2		
USB2.0	2 x USB2.0		
DisplayPort	2 x DP		
Storage	2 x 2.5" Swap SSD Tray		



POWER REQUIREMEN

Power Input	DC-IN 16~31V (With Redundant)	
OS SUPPORT I	lst	
OS	Windows® 11 64bit, / Windows® 10 IoT LTSC 64bit (LTSC 2021) /Ubuntu 22.04 / Linux (support by request)	
MECHANICAL A	ND EVVIRONMENTAL	
Dimension	220 x 315 x167 mm (W x D x H)	
Operating Temp.	-20°C to 60°C	
Storage Temp.	-40°C to 85°C	
Relative Humidity	5% to 95%, non-condensing	
System Design	Fanless	
CERTIFICATION		

CERTIFICATION

IEC-61850-3 / IEEE-1613 / UL 62368-1 / EN60945 / CE / FCC

Ordering Information

SCX3X2-DC

Smart Energy Fanless Computer with Intel 13th /12th Gen Intel® Raptor Lake-S/Alder Lake-S LGA1700 Socket Processor / Core i9/i7/i5/i3 Processor TDP 65W, up to 64G SO-DIMM DDR4 3200MHz, 2 × 1GbE, 2 x USB3.2, 2 x USB3.0, 2 x USB2.0, 2 x DP, 2 x 2.5" SwapSSD Tray, DC-IN 16~31V, Operating Temperature -20°C~+60°C

SCX3X2-RDC

Smart Energy Fanless Computer with Intel $13^{th}/12^{th}$ Gen Intel® Raptor Lake-S/Alder Lake-S LGA1700 Socket Processor / Core i9/i7/i5/i3 Processor / TDP 65W, up to 64G SO-DIMM DDR4 3200MHz, 2 × 1GbE, 2 x USB3.2, 2 x USB3.0, 2 x USB2.0, 2 x DP, 2 x 2.5" SwapSSD Tray, DC-IN 16~31V with redundant, Operating Temperature -20°C~+60°C

	SCH3X2-DC	SCH3X2-RDC	
CPU	12/13th Gen Intel® Core i9/i7/i5/i3		
RAM	Processor TDP 65W Up to 64GB SO_DIMM, DDR4-3200MHz		
	2 x PCle Gen4 x 8		
Expansion	1 x M.2 2280(Gen3 x 4,SATAIII)		
Storage	Up to 4TB SATAIII		
Storage	Up to 2TB NVMe & SATAIII		
I/O	2 × RJ45, 6 x USB, 2 x DP, 2 x 2.5″ SwapTray		
Power	DC-IN 16~31V	DC-IN 16~31V W/Redundant	
Operation Temp.	-20°C~+60°C		



Accessories Kit (Option)

P/N	Description	Q'ty
0ZAKSCH3X2000000	Accessories Kit for SCH3X2/SCH4X2 Dual	1
	Machine Rackmount Bracket	
0ZAKSCH3X2000001	Accessories Kit for SCH3X2/SCH4X2 Single	1
	Machine Rackmount Bracket	I

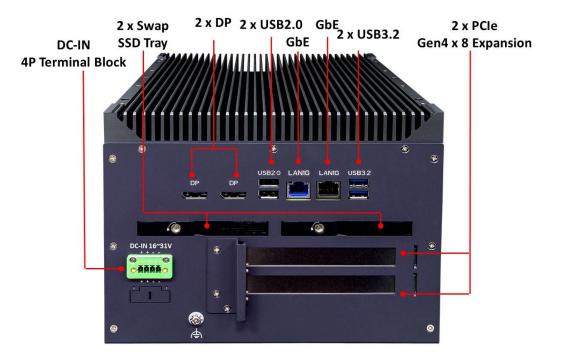


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Appearance

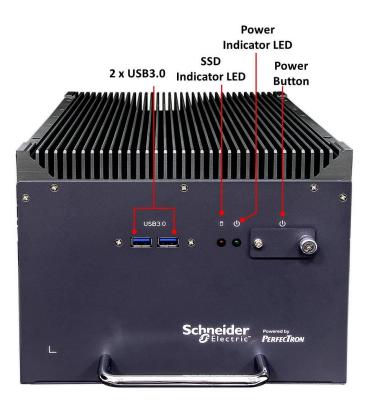
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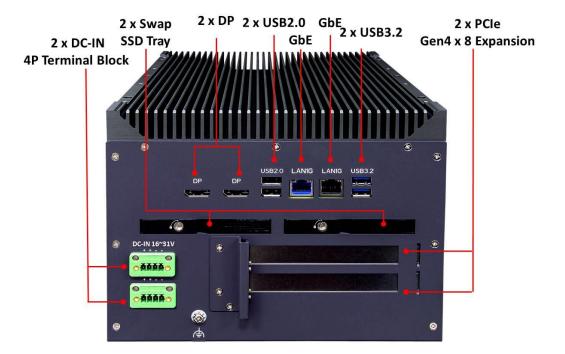






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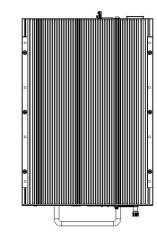


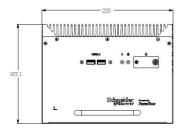




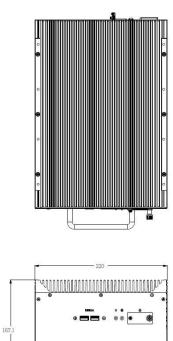
Drawing and Dimension

SCH3X2-DC:





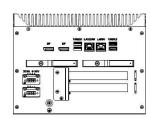
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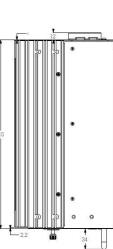


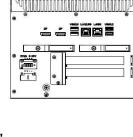
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